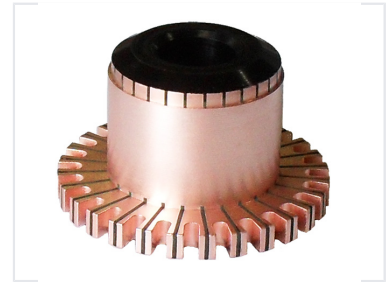


Cylindrical Copper Heat Sink with Radial Fins

This precision-engineered copper heat sink ensures efficient thermal dissipation. Its cylindrical body features a radial fin design to maximize surface area and optimize heat transfer for high-performance electronic components.



Product Overview

High-Performance Thermal Management

This precision-engineered copper heat sink is specifically designed for efficient thermal dissipation in high-performance electronic components. Its cylindrical body features a distinct black top section and a base with radial fins, which significantly maximizes surface area for optimal heat transfer. The use of high-quality copper ensures excellent thermal conductivity, while the radial fin geometry promotes superior airflow and efficient heat exchange.

Technical Specifications

Key Thermal Benefits

- High thermal conductivity
- Maximised surface area for dissipation
- Enhanced airflow design

Material	Copper
Design Features	Cylindrical Body, Radial Fins, Black Top Section
Application	High-performance electronic components